

IRFS240B

200V N-Channel MOSFET

General Description

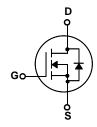
These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency switching DC/DC converters, switch mode power supplies, DC-AC converters for uninterrupted power supply and motor control.

Features

- 12.8A, 200V, $R_{DS(on)}$ = 0.18 Ω @V_{GS} = 10 V Low gate charge (typical 45 nC)
- Low Crss (typical 45 pF)
- Fast switching
- 100% avalanche tested
- · Improved dv/dt capability





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		IRFS240B	Units	
V _{DSS}	Drain-Source Voltage		200	V	
I _D	Drain Current - Continuous (T _C = 25°	C)	12.8	A	
	- Continuous (T _C = 100)°C)	8.1	A	
I _{DM}	Drain Current - Pulsed	(Note 1)	51.2	Α	
V _{GSS}	Gate-Source Voltage		± 30	V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	250	mJ	
I _{AR}	Avalanche Current	(Note 1)	12.8	A	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	7.3	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	5.5	V/ns	
P_{D}	Power Dissipation (T _C = 25°C)		73	W	
	- Derate above 25°C		0.59	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	

Thermal Characteristics

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		1.7	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		40	°C/W

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units	
Off Cha	aracteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$					V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C			0.2		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 200 V, V _{GS} = 0 V				10	μΑ
		V _{DS} = 160 V, T _C = 125°C	;			100	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 30 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -30 \text{ V}, V_{DS} = 0 \text{ V}$				-100	nA
On Cha	racteristics						
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		2.0		4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} =10 V, I _D =6.4 A		0.145	0.18	Ω	
9 _{FS}	Forward Transconductance	V _{DS} = 40 V, I _D = 6.4 A	(Note 4)		11.3		S
	ic Characteristics	T			4200	4700	
Ciss	Input Capacitance	$V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$			1300	1700	pF
C _{oss}	Output Capacitance Reverse Transfer Capacitance	f = 1.0 MHz			175 45	230 60	pF pF
orss	Neverse Hansier Capacitance				40	00	рі
Switchi	ng Characteristics						
t _{d(on)}	Turn-On Delay Time	V _{DD} = 100 V, I _D = 18 A,			20	50	ns
t _r	Turn-On Rise Time	$R_G = 25 \Omega$			145	300	ns
t _{d(off)}	Turn-Off Delay Time	Ŭ.			145	300	ns
t _f	Turn-Off Fall Time		(Note 4, 5)		110	230	ns
Q_g	Total Gate Charge	$V_{DS} = 160 \text{ V}, I_{D} = 18 \text{ A},$			45	58	nC
Q_{gs}	Gate-Source Charge	V _{GS} = 10 V			6.5		nC
Q_{gd}	Gate-Drain Charge		(Note 4, 5)		22		nC
Drain-S	Source Diode Characteristics a	nd Maximum Rating	s				
I _S	Maximum Continuous Drain-Source Diode Forward Current					12.8	Α
I _{SM}	Maximum Pulsed Drain-Source Diode F	laximum Pulsed Drain-Source Diode Forward Current				51.2	Α
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = 12.8 \text{ A}$				1.5	٧
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_{S} = 18 \text{ A},$	(Note 4)		195		ns
Q _{rr}	Reverse Recovery Charge	dI _F / dt = 100 A/μs		1.47		μC	

- **Notes:**1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 2.3mH, I_{AS} = 12.8A, V_{DD} = 50V, R_G = 25 Ω, Starting T_J = 25°C 3. I_{SD} ≤ 18A, di/dt ≤ 300A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C 4. Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2% 5. Essentially independent of operating temperature

Typical Characteristics

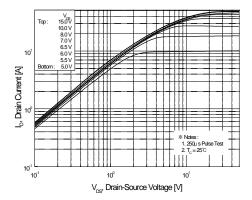


Figure 1. On-Region Characteristics

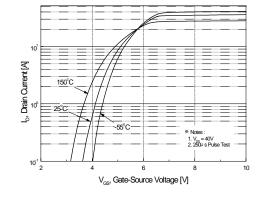


Figure 2. Transfer Characteristics

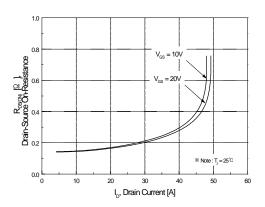


Figure 3. On-Resistance Variation vs Drain Current and Gate Voltage

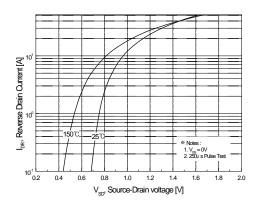


Figure 4. Body Diode Forward Voltage Variation with Source Current and Temperature

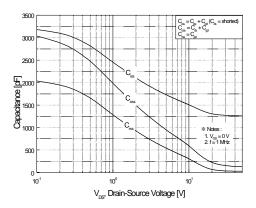


Figure 5. Capacitance Characteristics

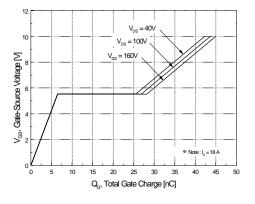
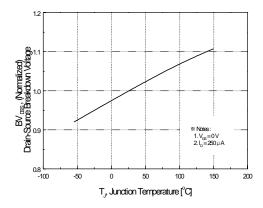


Figure 6. Gate Charge Characteristics

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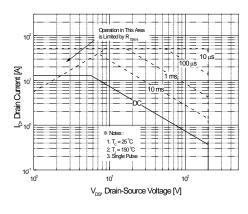
Typical Characteristics (Continued)



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Figure 7. Breakdown Voltage Variation vs Temperature

Figure 8. On-Resistance Variation vs Temperature



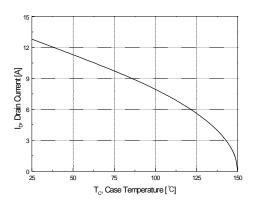


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs Case Temperature

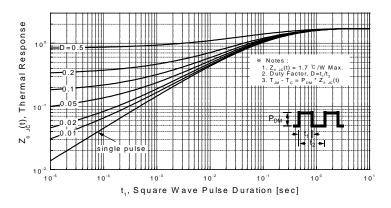
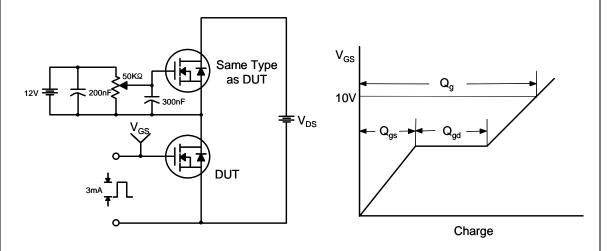


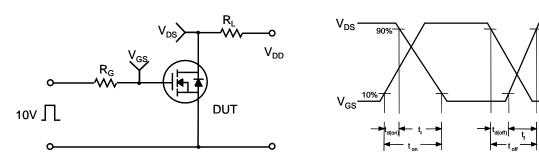
Figure 11. Transient Thermal Response Curve

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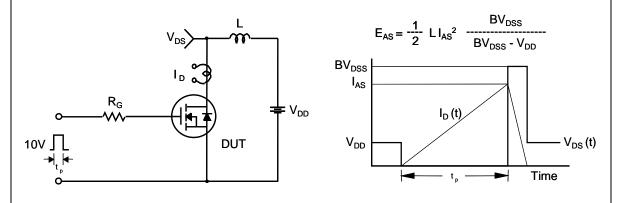
Gate Charge Test Circuit & Waveform



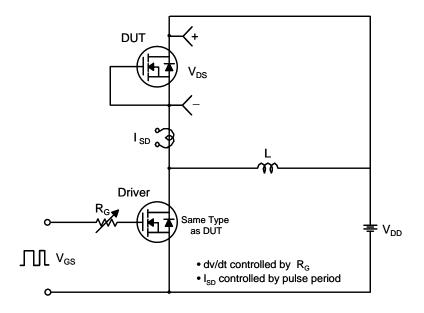
Resistive Switching Test Circuit & Waveforms

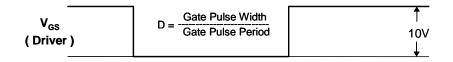


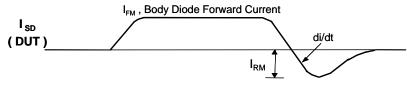
Unclamped Inductive Switching Test Circuit & Waveforms



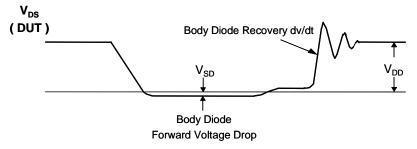
Peak Diode Recovery dv/dt Test Circuit & Waveforms

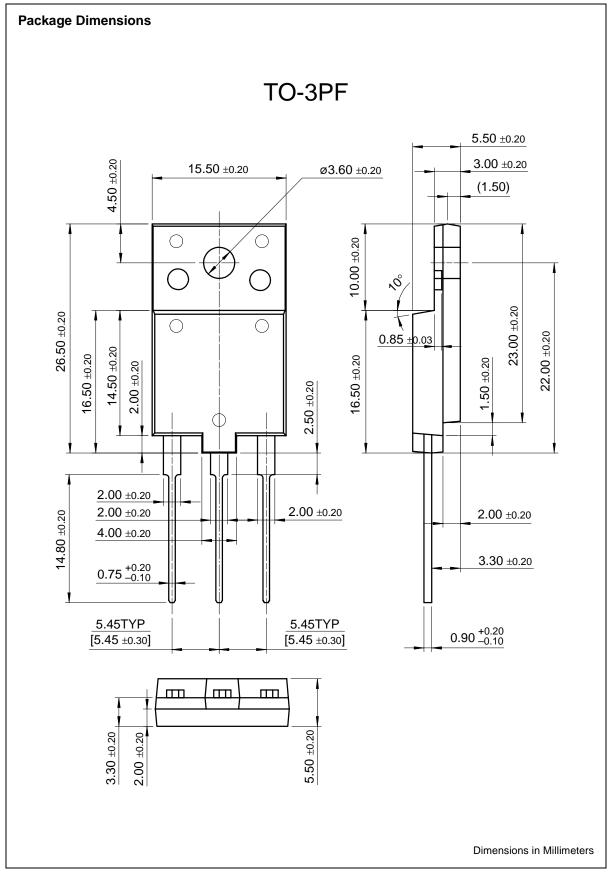






Body Diode Reverse Current





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IRFS240B

200V N-Channel B-FET / Substitute of IRFS240 & IRFS240A

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General description

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Product status/pricing/packaging



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Indicates product with Pb-free second-level interconnect. For more information click here.

Package marking information for product IRFS240B is available. Click here for more information.

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Qualification Support

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